# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
DEOK GON KIM	11/12/2012
MIN WOO KIM	11/12/2012
HYOUNG JIN KIM	11/12/2012
SUNG HOO HONG	11/12/2012

#### **RECEIVING PARTY DATA**

Name:	SAMSUNG MEDISON CO., LTD.
Street Address:	3366 HANSEO-RO, NAM-MYEON
Internal Address:	HONGCHEON-GUN
City:	GANGWON-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	250-874

# **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	13728488

#### **CORRESPONDENCE DATA**

Fax Number: (202)756-8087

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 756 8000

jsbrown@mwe.com, dwityak@mwe.com Email:

**HOSANG LEE Correspondent Name:** 

Address Line 1: MCDERMOTT WILL & EMERY LLP 500 NORTH CAPITOL STREET NW Address Line 2:

Address Line 4: WASHINGTON, D.C. 20001

ATTORNEY DOCKET NUMBER:	050665-0384
NAME OF SUBMITTER:	HOSANG LEE
SIGNATURE:	/Hosang Lee/
DATE SIGNED:	09/06/2016

**Total Attachments: 3** 

**PATENT** REEL: 039636 FRAME: 0662 source=50665-384\_Assignment#page1.tif source=50665-384\_Assignment#page2.tif source=50665-384\_Assignment#page3.tif

> PATENT REEL: 039636 FRAME: 0663

Attorney	Docket	No.	

# COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

### ULTRASOUND AND SYSTEM FOR FORMING AN ULTRASOUND IMAGE

which application is:

attached, or

United States application number or PCT international application number \_\_\_\_\_\_ filed on \_\_\_\_\_\_.

The above-identified application was made or authorized to be made by me.

In the event that the filing date and/or application number are not entered above at the time I execute this document, and if such information is deemed necessary, I hereby authorize and request the registered practitioners of McDermott Will & Emery LLP, associated with the Customer Number 20277, to insert above the filing date and/or application number of the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

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Attorney	Docket	No.	

# **ASSIGNMENT**

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

#### SAMSUNG MEDISON CO., LTD.

having an address at 3366, Hanseo-ro, Nam-myeon, Hongcheon-gun Gangwon-do, 250-874 Republic of Korea

(hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

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Attorney	Docket	No.	

Legal name of first inventor	
KIM, Deok Gon	
First inventor's signature	Date
	November 12, 2012
Legal name of second inventor, if any	
KIM, Min Woo	
Second inventor's signature	Date
KIM, Min Woo	November 12, 2012
Legal name of third inventor, if any	
KIM, Hyoung Jin	
Third inventor's signature	Date
Hyoung Jin Kim	November 12, 2012
Legal name of fourth inventor, if any	
HONG, Sung Hoo	
Fourth inventor's signature	Date
Hong Sury Hoo	November 12, 2012